Coversheet

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■Preliminary Specification□Final Product Specification

Customer :		
Approved by		Notes
GVO Confirmed :		
Prepared by	Checked by	Approved by

This technical specification is subjected to change without notice.



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Record of Revision

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A0	2016.11.15	Draft	Zhao Tianyu



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1 General Specifications

	Feature	Spec	Remark
	Screen Size (inch)	5.48	
	Display Mode	AMOLED	
	Resolution(dot)	1080(W)×1920(H)	
	Active Area(mm)	68.256(W)×121.344 (H)	
Display Spec	Pixel Pitch (um)	94.8 (W)×63.2(H)	
	Technology Type	LTPS	
	Color Depth	16.7M	
	Interface	MIPI 4LANE	
	Surface Treatment	Hard Coating	
Machanical	With TP/Without TP	With TP(on Cell)	
Mechanical Characteristi cs	Module Outline Dimension(W x H x D) (mm)	73.56 (W)x148.86(H)x1.92(D)	Including Cover lens
CS	Weight (g)	TBD	
Electronic	Driver IC(Type)	RM67198	
LIGOTIONIC	Touch IC(Type)	GT1151	

Note 1: Requirements on Environmental Protection: RoHS.



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2 Input/output Terminals

2.1 Main FPC Pin Assignment

FPC connector: AXE340124, B-TO-B Connector.

Main board recommended connector: AXE440124 B-TO-B Connector.

No	Symbol	I/O	Description	
1	VPP	Р	Power supply for MTP Programming or Erase. If	
<u>'</u>	VFF	r 	it is not used please open it.	
2	D3N	I	MIPI data lane	
3	NC		NC	
4	D3P	I	MIPI data lane	
5	ELON2	0	DC/DC Power IC S-Wire CTRL Pin	
6	GND	GND	Ground	
7	VDDP_EN	0	DC/DC Power Enable Pin	
8	D0N	I/O	MIPI data lane	
9	PCD	0	Panel Crack Detection Pin	
10	D0P	I/O	MIPI data lane	
11	TE	I	Sync Signal for preventing Tearing Effect	
12	GND	GND	Ground	
13	ERR_FG	0	MIPI Error Pin	
14	CKN	I	MIPI clock lane	
15	RESX	I	Display reset. Active low.	
16	СКР	I	MIPI clock lane	
17	VDDIO	Р	Power supply for display logic circuits	
18	GND	GND	Ground	
19	TSP_1.8V	Р	Power supply for display logic circuits	
20	D1N	I	MIPI data lane	
21	VLIN_6.5V	Р	External Power Input for AVDD	
22	D1P	I	MIPI data lane	
23	VCI	Р	Power supply for display analog circuits	
24	GND	GND	Ground	
25	TSP_SDA	I/O	SDA pin for TP	



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26	D2N	I	MIPI data lane		
27	TSP_SCL	I	SCL pin for TP		
28	D2P	I	MIPI data lane		
29	TSP_ATTN	I	INT pin for TP		
30	GND	GND	Ground		
31	TSP_ 3.3V	Р	Analog Power for TP		
32	TSP_RESET	I	Reset Pin for TP, Active low.		
33	TSP_1.8V	Р	Power supply for TP logic circuits		
34	NC		NC		
35	ELVDD	Р	Positive power supply for EL		
36	ELVSS	Р	Negative power supply for EL		
37	ELVDD	Р	Positive power supply for EL		
38	ELVSS	Р	Negative power supply for EL		
39	ELVDD	Р	Positive power supply for EL		
40	ELVSS	Р	Negative power supply for EL		

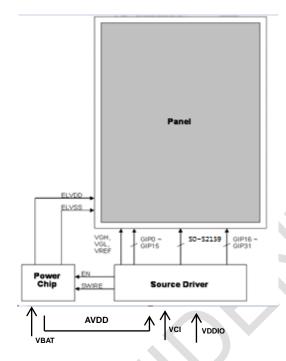
Note: I=Input; O=Output; P=Power; I/O=Input / Output

2.2 TP FPC Pin Assignment-On-cell TP Input / Output Signal Interface

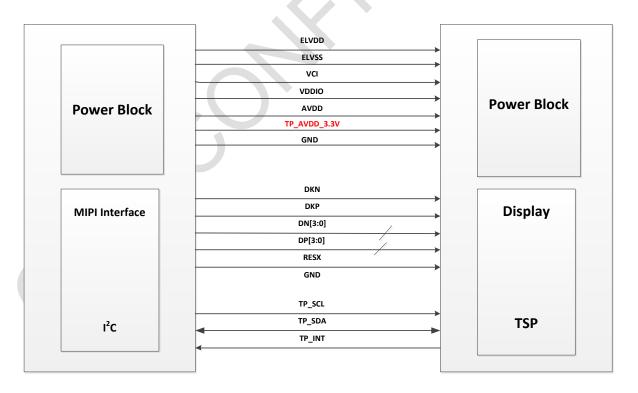
No	Symbol	I/O	Description
1	TSP_DVDD_1.8V	Power	Power supply for display logic circuits
2	TSP_RESET	l	Reset Pin for TP, Active low
3	TSP_AVDD_3.3V	Power	Analog Power for TP
4	TSP_SDA	I/O	SDA pin for TP
5	TSP_SCL	I/O	SCL pin for TP
6	TSP_ATTN	I/O	INT pin for TP
7	GND	GND	Ground

2.3 Circuit block diagram (Display)





2.4 MCU and Display Module Interface Conflagration





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3 Absolute Maximum Ratings

3.1 Driving AMOLED Panel

Maximum Ratings (Voltage Referenced to VSS) Vss=0V, Ta=25℃

Item	Symbol	MIN	MAX	Unit
Analog Power supply	VCI	-0.3	+5.0	V
Logic Power supply	VDDIO	-0.3	+4.0	V
Positive Power Input	ELVDD	-	+5.0	V
Negative Power Input	ELVSS	-5.0		V

Note: Functional operation should satisfy the limits in the Electrical Characteristics tables or Pin Description section. If the module exceeds the absolute maximum ratings, permanent damage may occur. Besides, if the module is operated with the absolute maximum ratings for a long time, the reliability may also drop.

4 Electrical Characteristics

4.1 Driving AMOLED Panel

Ta=25°C

Item		Symbol	MIN	TYP	MAX	Unit
Logic Power s	supply	VDDIO	1.65	1.80	3.30	V
Analog Power	supply	VCI	2.65	2.80	3.60	V
ELVDD Suppl	y Voltage	ELVDD	4.55	4.60	4.65	V
ELVSS Supply	y Voltage	ELVSS	-1	TBD	-5	V
Input Signal	High Level	VIH	0.80*VDDIO	ı	VDDIO	V
Voltage	Low Level	VIL	0.00		0.20*VDDIO	٧
Output Signal	High Level	VOH	0.80*VDDIO	ı	VDDIO	V
Voltage	Low Level	VOL	0.00	-	0.20*VDDIO	V

Note1: The input digital voltage is the I/O reference voltage.

Note2: VDDIO usually ranges from 1.65V to 1.95 V. If VDDIO is changed, the remaining voltage needs to be changed to the same voltage as VDDIO.



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4.2 Current Consumption

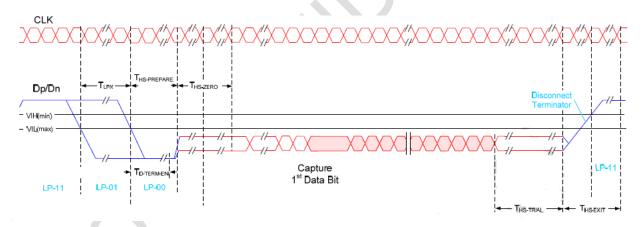
<u> </u>	Surrent Sonsamption							
Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Remark
Panel P	ower	P _{NL}	ELVDD=4.6V	-	TBD	TBD	mW	Note1
		I _{NL}	ELVSS=TBD	-	191.80	TBD	mA	Note2
	Normal	I _{VCI}	VCI=2.8V		1.5	TBD	mA	-
IC		I _{IOVCC}	VDDIO=1.8V		42	TBD	mA	/
	Otana di Inc.	I _{VCI}	VCI=2.8V		1	TBD	uA	-
	Stand-by	I _{IOVCC}	VDDIO=1.8V		1	TBD	uA	-

Note1: Based on L255 (350nit) full white pattern.

Note2: Video Mode 60Hz.

5 AC Characteristics

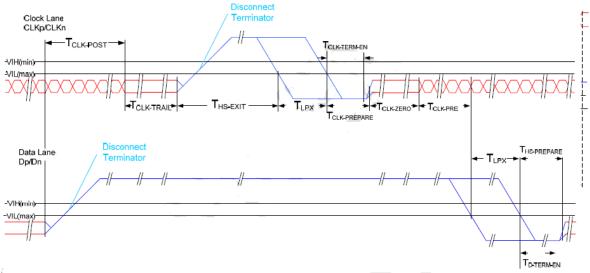
5.1 MIPI Interface Characteristics HS Data Transmission Burst



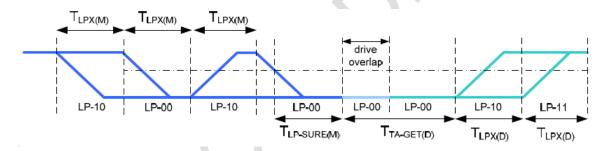


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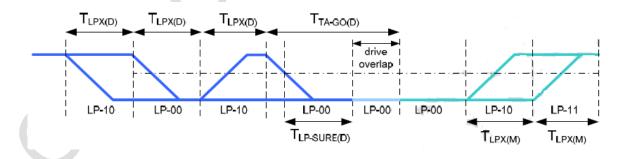
HS clock transmission



Turnaround Procedure



Bus turnaround (BAT) from MPU to display module timing



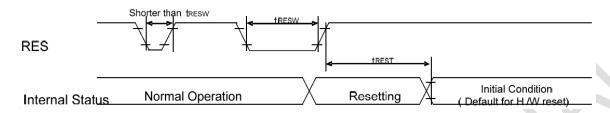
Timing Parameters:



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Parameter	Description		Min	Тур	Max			Unit
T _{CLK-POST}	Time that the transmitter continues to	send	60ns + 52*UI	. , , ,			_	ns
· CLK-POST	HS clock after the last associated Date		30113 : 32 31					
	Lane has transitioned to LP Mode. In							
	is defined as the period from the end							
	T _{HS-TRAIL} to the beginning of T _{CLK-TRAIL}							
T _{CLK-TRAIL}	Time that the transmitter drives the H	S-0	60					ns
CERTRAIL	state after the last payload clock bit of							
	transmission burst.							
T _{HS-EXIT}	Time that the transmitter drives LP-11		300					ns
- HO-EXII	following a HS burst.							
T _{CLK-TERM-EN}	Time for the Clock Lane receiver to e	nable	Time for Dn to		38			ns
OEK-TEKW-EN	the HS line termination, starting from		reach $V_{TERM-EN}$					
	time point when Dn crosses V _{IL,MAX} .		TERMI-LIN					
T _{CLK-PREPARE}	Time that the transmitter drives the C	lock	38		95			ns
· CER-FREFARE	Lane LP-00 Line state immediately be							
	the HS-0 Line state starting the HS							
	transmission.							
T _{CLK-PRE}	Time that the HS clock shall be driver	ı bv	8					UI
OEK-I NE	the transmitter prior to any associated							
	Lane beginning the transition from LP							
	HS mode.	. 4						
T _{CLK-PREPARE}	T _{CLK-PREPARE} + time that the transmitte	r	300					ns
+ T _{CLK-ZERO}	drives the HS-0 state prior to starting							
· CER-ZERO	Clock.							
T _{D-TERM-EN}	Time for the Data Lane receiver to en	able	Time for Dn to		35 ns	+4*UI		
D-TERMI-EN	the HS line termination, starting from		reach V _{TERM-EN}					
	time point when Dn crosses V _{IL,MAX} .		TERWI-EN					
T _{HS-PREPARE}	Time that the transmitter drives the D	ata	40ns + 4*UI		85 ns	+ 6*U	i t	ns
1 HS-PREPARE	Lane LP-00 Line state immediately be		10110 . 1 01		30 110		.	
	the HS-0 Line state starting the HS							
	transmission							
T _{HS-PREPARE}	T _{HS-PREPARE} + time that the transmitt	er	145ns + 10*UI					ns
+ T _{HS-ZERO}	drives the HS-0 state prior to	-						
- 113-2ERO	transmitting the Sync sequence.							
T _{HS-TRAIL}	Time that the transmitter drives the fli	pped	60ns + 4*UI					ns
TIOTIVALE	differential state after last payload da							
	of a HS transmission burst							
Parameter	Description	Min	Тур	T M	ax	Unit	No	tes
T _{LPX(M)}	Transmitted length of any Low-Power	50	71		50	ns	1,2	
El X(m)	state period of MCU to display module						-,_	
T _{TA-SURE(M)}	Time that the display module waits after	T _{LPX(M)}		2,	T _{LPX(M)}	ns	2	
,	the LP-10 state before transmitting the							
	Bridge state (LP-00) during a Link							
	Turnaround.							
$T_{LPX(D)}$	Transmitted length of any Low-Power	50		1:	50	ns	1,2	2
	state period of display module to MCU							
$T_{TA-GET(D)}$	Time that the display module drives the		5*T _{LPX(D)}			ns	2	
	Bridge state (LP-00) after accepting							
_	control during a Link Turnaround.		44=				_	
$T_{TA-GO(D)}$	Time that the display module drives the		4*T _{LPX(D)}			ns	2	
	Bridge state (LP-00) before releasing							
_	control during a Link Turnaround.	-			· T			
T _{TA-SURE(D)}	Time that the MPU waits after the LP-10	T _{LPX(D)}		2	T _{LPX(D)}	ns	2	
	state before transmitting the Bridge							
	state (LP-00) during a Link Turnaround.							

5.2 Display RESET Timing Characteristics Reset input timing:



VDDIO=1.65 to 3.3V, VDD=2.7 to 3.6V, AGND=DGND=0V, Ta=-40 to 85° C

Timing Parameters

Symbol	Parameter	Related Pins	MIN	TYP	MAX	Note	Unit
t _{RESW}	*1) Reset low pulse width	RESX	10	-	-	-	μS
+0\ 5	*2) Decet complete time	-	-	-	5	When reset applied during Sleep in mode	ms
t _{REST}	*2) Reset complete time	-		-	120	When reset applied during Sleep out mode	ms

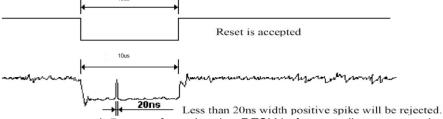
Note1. Spike caused by an electrostatic discharge on RESX line does not cause irregular system reset according to the table below.

RESX Pulse	Action		
Shorter than 5µs	Reset Rejected		
Longer than 10μs	Reset		
Between 5μs and 10μs	Reset starts (It depends on voltage and temperature condition.)		

Note 2. During the resetting period, the display will be blank (The display is entering blanking sequence, whose maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains blank in Sleep In –mode) and then return to Default condition for H/W reset.

Note 3. During Reset Complete Time, data in OTP will be latched to internal register during this period. This loading is done every time when there is H/W reset complete time (tREST) within 5ms after a rising edge of RESX.

Note 4. Spike Rejection also applies during a valid reset pulse as shown below:



Note 5. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out



5.3 TE Timing Characteristics

Mode1, The Tearing Effect Output line consists of V-Blanking information only.

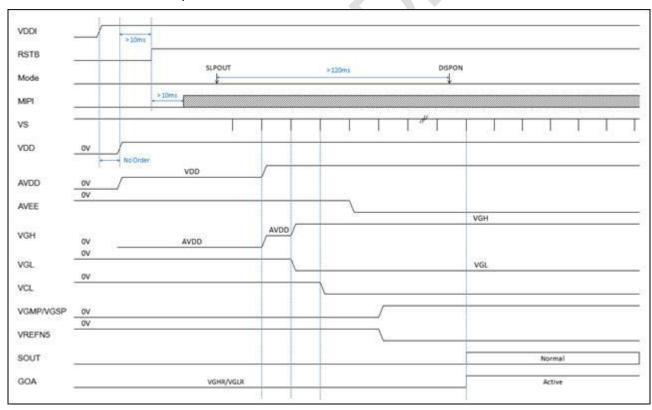


Tvdh = The LCD display is not updated from the frame memory. Tvdl = The LCD display is updated from the frame memory.

6 Recommended Operating Sequence

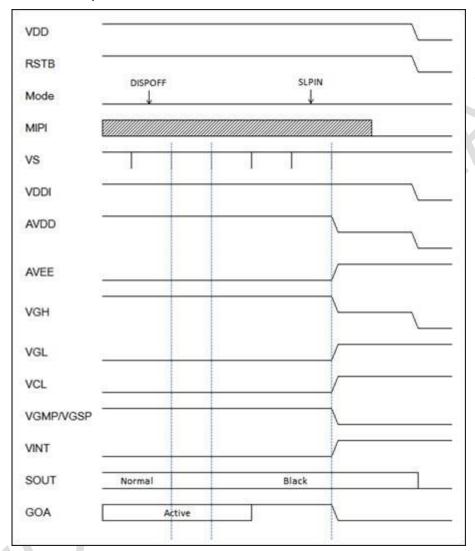
6.1 Display Power on / off Sequence

6.1.1 Power On Sequence





6.1.2 Power Off Sequence



6.2 Display Initial code

TBD

6.3 Brightness control

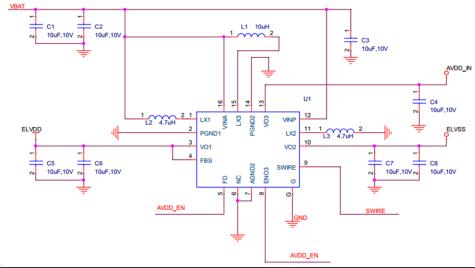
In at/Dava	DAM	Addr	ress	Doto Tuno	Description
Inst/Para	R/W	MIPI	Other	Date Type	Description
BRTCTRL	W	51h	5100h	Hex	Value form 0~255(FF)



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7 Application Circuit

Concerning ELVDD&ELVSS & AVDD power supply schematic, the Triple DC/DC converter TPS65651/ RT4722 is recommended. The application schematics and external components are as below.



Description	Part Reference	Manufacturer	Manufacturer PN
10uF, 10V, +20%, X5R, 0402	C1, C2, C3, C4, C5, C6, C7, C8	Murata	GRM155R61A106ME44D
10ur, 10v, ±20%, x5k, 0402	C1, C2, C3, C4, C5, C6, C7, C8	Samsung	CL05A106MP5NUNC
Power Inductor, 10uH, 20%, LS2520	T 1	成育科技	ACDNR252010UP-100MT
rower inductor, 10th, 20%, LS2520	LI	科明电子	KMPHS252010-100M
D I 4 7.41 90W 189590	10.15	成育科技	ACDNR252010T-4R7MT
Power Inductor, 4.7uH, 20%, LS2520	L2, L3	科明电子	KMPHS252010-4R7M
OFN1C (2, OV2, O)	111	TI	TPS65651
QFN16(3.0X3.0)	UI	RICHTEK	RT4722

8 Optical Characteristics Optical Specification

Item	Symbol	Condition	Min	Тур	Max	Unit	Remark
	θТ		75	85			
Viow Anglo	θВ	CR≥10	75	85			Note 2
View Angle	θL		75	85		Degree	Test Equipment: CS2000A
	θR		75	85			
		θ=0°	10000				Note1
Contrast Ratio	CR						Note3
Contrast Italio							Test Equipment: CS2000A
Response Time	T _{ON}	25 ℃			1	ms	Note1



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		T_{OFF}						Note4 Test Equipment: Admesy MSE
	White	X		(0.280)	(0.300)	(0.320)		
	vviile	у		(0.300)	(0.320)	(0.340)		
	Red	x		(0.620)	(0.660)	(0.700)		Test Equipment: CS2000A
Chromaticity		у		(0.290)	(0.330)	(0.370)		Note: Chromaticity
Cilionialicity	Green	х		(0.200)	(0.250)	(0.300)		can be modified
	Green	у		(0.660)	(0.710)	(0.760)		according to customer demand
	Blue	x		(0.110)	(0.140)	(0.170)		domana
	Diue	У		(0.030)	(0.060	(0.090)		
Uniformity		U		75			%	Note1 Note6 Iuminance of center point is 350±35nits Test Equipment: CS2000A
NTSC				85	100		%	Note5
Luminance		L		280	350	420	Cd/m ²	Note1 Note7 Test Equipment: CS2000A
Cross-talk						1.5	%	Note8 L≤350nits Test Equipment: CS2000A
Gamma				2.0	2.2	2.4		Gamma=2.2±0.2 (L≤ 350nits); Gamma Self-adjustment (L> 350nits) Test Equipment: CS2000A
Flicker				-	-	-	db	Note9 Customer RFQ did not mentioned the item
Color Tempe	rature			-	-	-	K	Test Equipment:



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	SI IAN G	OVISIONOX C	TIOLLL	CINONIC	3 CO., LIL	013-	+0F11101GF-001
							CS2000A Customer RFQ did not mentioned the item
Color shift		-	-	-	-	JNCD	Note10 Customer RFQ did not mentioned the item
Gray-scale	Delta Tc	Gray-scale	-	-	-	К	Test Equipment: CS2000A Customer RFQ did not mentioned the item
transition	Delta u'v'	Gray-scale	-	-	-	-	Test Equipment: CS2000A
Color Uniformity			-	-	-		Full White Customer RFQ did not mentioned the item

Test Conditions:

the ambient temperature is 25 $^{\circ}$ C.

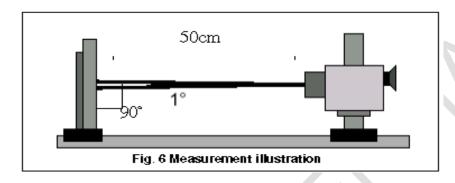
1. The test systems refer to Note1 and Note2.



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Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. The optical properties are measured at the center point of the AMOLED screen. All input terminals AMOLED panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system.

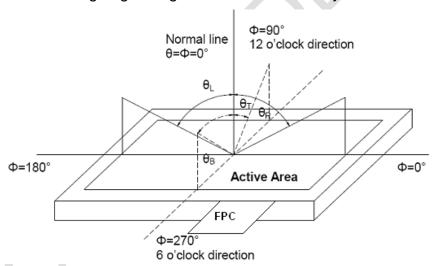


Fig. 1 Definition of viewing angle



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Note 3: Definition of contrast ratio

 $Contrast\ ratio(CR) = \frac{Lu\, min\, ance\, measured\, when\, LCD\, is\, on\, the\, "white"\, state}{Lu\, min\, ance\, measured\, when\, LCD\, is\, on\, the\, "Black"\, state}$

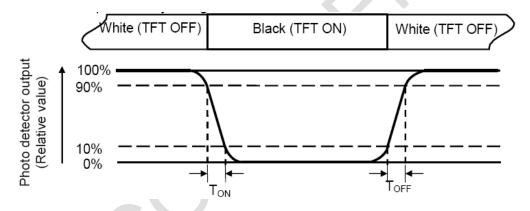
"White state ": A state where the AMOLED should be driven by Vwhite.

"Black state": A state where the AMOLED should be driven by Vblack.

Note 4: Definition of response time

The response time is defined as the AMOLED optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time betwe

g from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changing from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates are measured at the center point of AMOLED.



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Note 6: Definition of luminance uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity(U) = Lmin/Lmax

L-----Active area length W----- Active area width

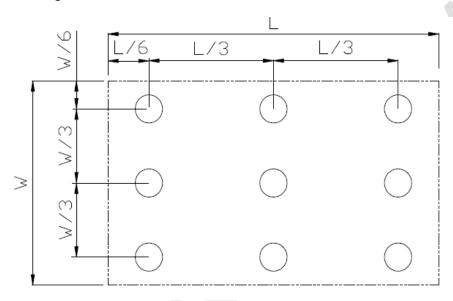


Fig. 2 Definition of uniformity

Lmax: The measured maximum luminance of all measurement position.

Lmin: The measured minimum luminance of all measurement position.

Note 7: Definition of luminance:

Measure the luminance of white state at the center point.

Note 8: Cross Talk

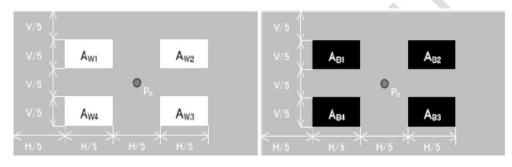
A. Measure luminance at the position, Po.

B. Calculate cross talk as below equation.

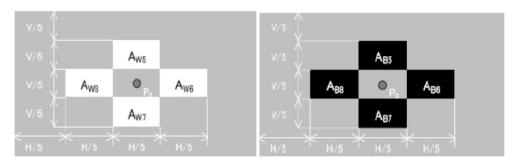


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$$\begin{split} L_{W_OFF} &= \frac{L_{W1} + L_{W2} + L_{W3} + L_{W4}}{4} \\ L_{B_OFF} &= \frac{L_{B1} + L_{B2} + L_{B3} + L_{B4}}{4} \\ crosstalk &= \frac{\left| L_{Wi_ON} - L_{W_OFF} \right|}{L_{W_OFF}} \times 100\% \qquad (i = 5 \text{ to } 8) \\ crosstalk &= \frac{\left| L_{Bi_ON} - L_{B_OFF} \right|}{L_{B_OFF}} \times 100\% \qquad (i = 5 \text{ to } 8) \end{split}$$



(a) Lw_OFF, LB_OFF measuring pattern



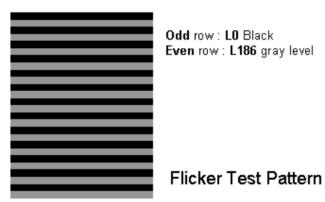
(b) Lw on, LB on measuring pattern



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Note 9: Flicker

Suggested Instrument s: Konica Minolta CA-310 or Klein Instruments K-8



The flicker level is defined by Fast Fourier Transformation (FTT) as follows:

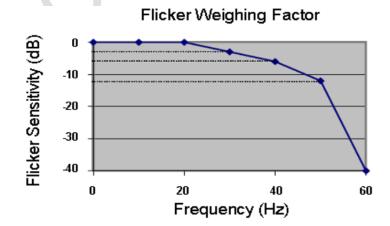
Flic ker =
$$20 \log_{10} \left(2 \frac{f_{FFTC}(n)}{f_{FFTC}(0)} \right) + FS(Hz)$$
 (dB)

 $f_{FFTC}(n)$ is the n-th FFT coefficient.

f_{FFTC}(0) is the 0-th FFT coefficient that is DC component.

FS(Hz) is the flicker sensitivity as a function of frequency.

The peak flicker level shall be reported based on the calculation using above formula in which FS(Hz) is determined by the flicker weighing factor shown below.





- For JNCD measure:
- · Test pattern: Full White
- On the condition θ =0 F=0°, we can get the color coordinate (u1', v1') and on 30° we can get another color coordinate (u2', v2')
- Delta = Square Root((u2'-u1')^2 + (v2'-v1')^2)
- JNCD stands for "Just Noticeable Color Difference"
- For the (u', v') color space JNCD=0.0040.
- 2JNCD means Delta u'v'<0.0080
- This Requirement is from our customer and we have test some of our phone display and the result is OK.



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9 Environmental / Reliability Test

No	Test Item	Condition	Remark
1	High Temperature Operation	+60℃, 120hrs	IEC60068-2-2,GB2423.2
2	Low Temperature Operation	-20℃, 120hrs	IEC60068-2-1 GB2423.1
3	High Temperature Storage	+70℃, 120hrs	IEC60068-2-2 GB2423.2
4	Low Temperature Storage	-30℃, 120hrs	IEC60068-2-1 GB2423.1
5	High Temperature & High Humidity Operation	60℃, 90% RH,120hrs	IEC60068-2-78 GB/T2423.3
6	Thermal Shock (Non-operation)	-40(°C)/30(min) ~+85 (°C)/30(min), Change time:10min, 30Cycles	Start with cold temperature, End with high temperature, IEC60068-2-14,GB2423.22
7	High Temperature & High Humidity Storage	60℃, 90% RH,120hrs	IEC60068-2-78 GB/T2423.3
8	ESD	Air:+/-8KV,Contact:+/-4KV	IEC61000-4-2 GB/T17626.2



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10 Quality Level

10.1 AMOLED Module of Characteristic Inspection

The environmental condition and visual inspection shall be conducted as below:

(1) Ambient temperature: 20~25°C

(2) Humidity: 55 ± 10%RH

(3) Ambient light intensity of visual inspection: 1000 ~ 1200 lux

(4) Ambient light intensity of function inspection: 100~150lux

(5) Viewing Distance: 30 ± 5cm

(6) Viewing angle (tolerance): the front side 45° (Z) ±15°

(7) Inspection time: 10 ±2 sec

10.2 Sampling Procedures for each item acceptance table

Defect type	Sampling Procedures	AQL
Major defect	GB/T2828.1-2003 Inspection level II normal inspection single sample inspection	0.25
GB/T2828.1-2003 Inspection leve Minor defect normal inspection single sample inspection		0.65

Major defect:

Any defect may result in functional failure, or reduce the usability of product for its purpose, such as electrical failure, deformation and so on.

Minor defect

A defect does not reduce the usability of product for its intended purpose, such as dot defect and so on.

The criteria on major and/or minor judgment will be according with the classification of defects.



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10.3 Inspection Item

	ection Item				Defect		
No.	Item	Criterion of Defect					
		D≤	0.1	Ignore	type		
1	Bright Dot	0.1<	D≤0.2	N≤2 ,DS≥10mm			
	· ·	0.2	<d< td=""><td>Not allowed</td><td></td></d<>	Not allowed			
			Single	Ignore			
		(Pixel level)	Two connected dot	N≤4, DS≥10mm	Minor		
2	Dark Dot	iovoiy	Three connected dot	Not allowed			
		D≤	0.1	Ignore			
		0.1 <d≤0.2< td=""><td>N≤2,DS≥10mm</td><td></td></d≤0.2<>		N≤2,DS≥10mm			
	Dot Defect	D≪	0.10	Ignore(N≤3, DS≤10mm)			
3	(Concave dot/Black dot/ Bubble)	0.10mm <d≤0.15mm< td=""><td>≤2 (DS≥10mm)</td><td>Minor</td></d≤0.15mm<>		≤2 (DS≥10mm)	Minor		
	·	W≤0.03mm		Ignore			
4	Linear Defect(Fiber/ flocks)		0≤0.05mm, .0mm	≤2 (DS≥10mm)	Minor		
	HOCKS)	Other		Not allowed			
		W≤0.	.03mm	Ignore			
5	Panel Scratch		0≤0.05mm, .0mm	≤2 (DS≥10mm)	Minor		
		Ot	her	Not allowed			
6	NO Display		Not	allowed	Major		
7	Display unevenly	Not allowed					
8	Flashing Screen	Not allowed					
9	Missed line	Not allowed					
10	Mura		Limi	t sample	Major		
11	Newton's Ring		Limit sample				



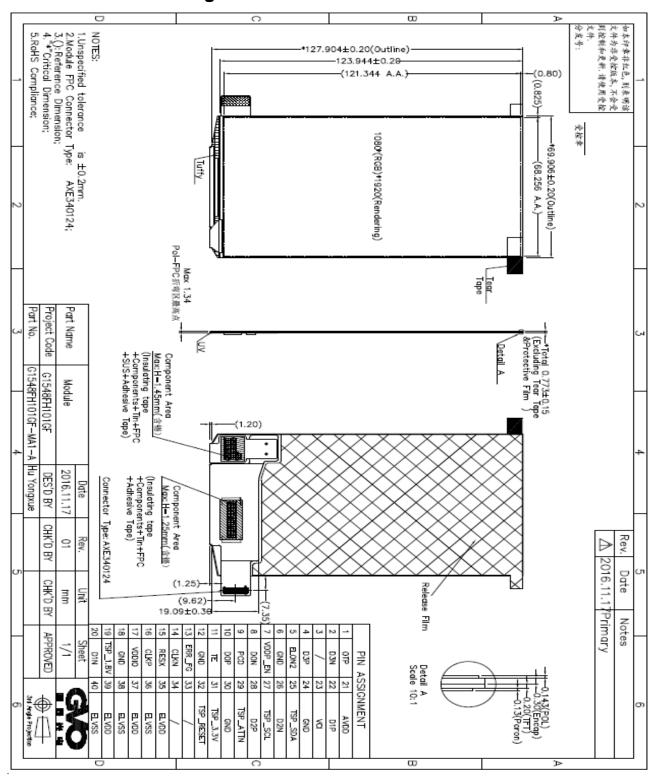
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12	Edge/Side breakage	Not allowed in AA and VA 1. 单玻璃区域 (a) 碳锌在 FOG 区域 2. 双玻璃区域 (b) 破锌在 FOG 区域 (b) 破锌在 FOG 区域 (c) 双玻璃区域 (c) 双玻璃区域	Major
13	FPCA	The component can not reverse polarity No wrong insertion FPC should not have serious crease which destroy the line, prick and spots damage. Scratch is not allowed if Cu layer is exposed. The gold fingers should not be oxidized, scraped, folded, impressed, broken, spotted or dissymmetry. Make sure FPC is not scalded, with its location holes not having deficiency or obviously shift. The component of FPC should be the same as BOM list. No remaining soldering Sn No visual particle on the pad line	Minor



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11 Mechanical Drawing

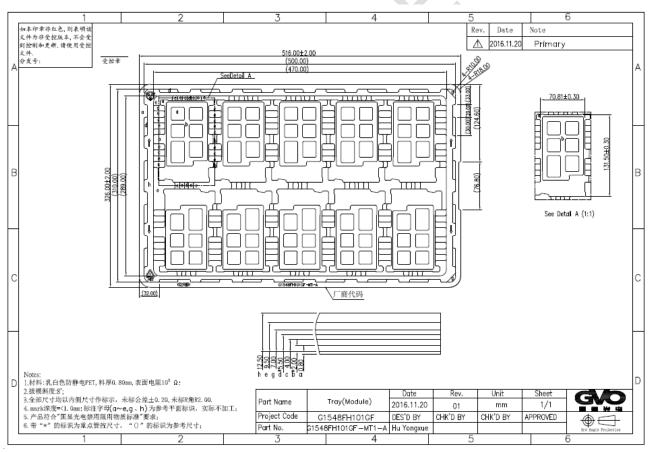




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Packing Drawing

Packing Condition	Contents
Packing Type	TRAY + Carton packing type
TRAY material model	tray (10 ⁵ ~10 ⁹ Ω)
Tray packing type	See the picture 1
Number of panels per tray	10 pieces
Number of Tray per carton	21units ((20 units + 1 empty)PET tray)
Number of panels per carton	200 pieces



Picture 1

12 Precautions for Use of AMOLED Modules

- 12.1 Handling Precautions:
- 12.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from height.
- 12.1.2 Do not press down the screen or the adjoining areas too hard because the color tone may be shifted.
- 12.1.3 The polarizer covering the display surface of the AMOLED module is soft and easily scratched. Handle this polarizer carefully.
- 12.1.4 If the display surface is contaminated, blow on the surface and gently wipe it with a soft dry cloth. If it is still not completely clear, moisten the cloth with ethyl alcohol.
- Solvents may damage the polarizer. Do not use water, ketone or aromatic solvents except ethyl alcohol.
 Do not attempt to disassemble the AMOLED Module.
- 12.1.6 If the logic circuit power is off, do not apply the input signals.
- 12.1.7 To prevent destruction from static electricity, be careful to maintain an optimum working environment.
- 12.1.8 Be sure to make yourself in contact with the ground when handling with the AMOLED Modules.
- 12.1.9 Tools required for assembly, such as soldering irons, must be properly ground.
- 12.1.10 To reduce the generation of static electricity, do not conduct assembly or other work under dry conditions.
- 12.1.11 To protect the display surface, the AMOLED Module is coated with a film. Be careful when peeling off this protective film, because static electricity may generate.
- 12.2 Storage Precautions:
- 12.2.1 When storing the AMOLED modules, be sure that they are not directly exposed to the sunlight or the light of fluorescent lamps.
- 12.2.2 The AMOLED modules should be stored under the storage temperature range. If the AMOLED modules will be stored for a long time, the recommended condition is: Temperature: 0°C~40°C Relatively humidity: ≤80%
- 12.2.3 The AMOLED modules should be stored in the room without acid, alkali or harmful gas.
- 12.3 Transportation Precautions:
- 12.3.1 The AMOLED modules should not be suffered from falling and violent shocking during transportation. Besides, excessive press, water, damp and sunshine, should be avoided.